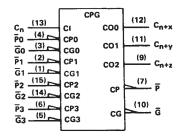
Directly Compatible for Use With: SN54LS181/SN74LS181, SN54S281/SN74S281, SN54S381, SN74S381, SN54S481/SN74S481

PIN DESIGNATIONS

	ALTERNATIVE	DESIGNATIONS†	PIN NOS.	FUNCTION
٠Г	GO, G1, G2, G3	G0, G1, G2, G3	3, 1, 14, 5	CARRY GENERATE INPUTS
Г	P0, P1, P2, P3	P0, P1, P2, P3	4, 2, 15, 6	CARRY PROPAGATE INPUTS
1	Cn	C _n	13	CARRY INPUT
	C _{n+x} , C _{n+y} , C _{n+z}	$\overline{C}_{n+x}, \overline{C}_{n+y}, \overline{C}_{n+z}$	12, 11, 9	CARRY OUTPUTS
Г	Ğ	Y	10	CARRY GENERATE OUTPUT
	P	×	7	CARRY PROPAGATE OUTPUT
٢	V	cc	16	SUPPLY VOLTAGE
$\cdot \Gamma$	G	ND	8	GROUND

[†]Interpretations are illustrated in the 'LS181, 'S181 data sheet.

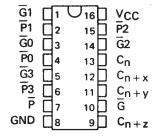
logic symbol‡



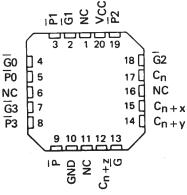
[‡]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54S182 . . . J OR W PACKAGE SN74S182 . . . D OR N PACKAGE (TOP VIEW)



SN54S182 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

description

The SN54S182 and SN74S182 are high-speed, look-ahead carry generators capable of anticipating a carry across four binary adders or group of adders. They are cascadable to perform full look-ahead across n-bit adders. Carry, generate-carry, and propagate-carry functions are provided as enumerated in the pin designation table above.

When used in conjunction with the 'LS181 or 'S181 arithmetic logic unit (ALU), these generators provide high-speed carry look-ahead capability for any word length. Each 'S182 generates the look-ahead (anticipated carry) across a group of four ALUs and, in addition, other carry look-ahead circuits may be employed to anticipate carry across sections of four look-ahead packages up to n-bits. The method of cascading 'S182 circuits to perform multilevel look-ahead is illustrated under typical application data.

The carry functions (inputs, outputs, generate, and propagate) of the look-ahead generators are implemented in the compatible forms for direct connection to the ALU. Reinterpretations of carry functions as explained on the 'LS181 and 'S181 data sheet are also applicable to and compatible with the look-ahead generator. Logic equations for the 'S182 are:

$$\begin{array}{lll} C_{n+x} = G0 + P0 \ C_n & \overline{C}_{n+x} = \underline{Y0 \ (X0 + C_n)} \\ C_{n+y} = G1 + P1 \ G0 + P1 \ P0 \ C_n & \overline{C}_{n+y} = \underline{Y1 \ [X1 + Y0 \ (X0 + C_n)]} \\ C_{n+z} = \underline{G2 + P2 \ G1 + P2 \ P1 \ G0 + P2 \ P1 \ P0 \ C_n} & \text{or} & \overline{C}_{n+z} = \underline{Y2 \ \{X2 + Y1 \ [X1 + Y0 \ (X0 + C_n)]\}} \\ \overline{P} = \underline{P3 \ P2 \ P1 \ P0} & \text{v} = \underline{Y3 \ (X3 + Y2) \ (X3 + X2 + Y1) \ (X3 + X2 + X1 + Y0)} \\ X = X3 + X2 + X1 + X0 & \underline{C}_{n+z} = \underline{Y0 \ (X0 + C_n)} \\ \hline C_{n+z} = \underline{Y0 \ (X0 + C_n)} \\ \overline{C}_{n+z} = \underline{Y0 \ (X0 + C_n)} \\ \overline{C}_{n+z$$

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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FUNCTION TABLE FOR G OUTPUT

		11	NPUT:	S			OUTPUT	
G3	G2	Ğ1	G0	P2	P1	Ğ		
L	Х	Х	Х	X X X X L X X L L	x x	X	L	
x	L	X	X		X	L		
х	X	L	X		L	L X	L	
×	XXXLLLL							
	All	othe	r comi	binati	ions		н	

FUNCTION TABLE FOR P OUTPUT

	INP	UTS		OUTPUT			
P3	P2	Ē1	ΡO	P			
L	L,	L	L	L			
	All d	other	•	Н			
C	mbi	''					

FUNCTION TABLE FOR C_{n+x} OUTPUT

H	NPUT	S	OUTPUT
Ğ0	P ₀	C _{n+x}	
L	Х	Х	Н
х	L	Н	н
A	II oth	er	1
com	binati	ions	-

FUNCTION TABLE FOR C_{n+y} OUTPUT

	IN		OUTPUT		
G1	G0	Cn	C _{n+y}		
L.	Х	Х	X	Х	Н
X	L	н			
x	X	L	L	Н	н
	ΑI				
	coml	oinat	ions		<u> </u>

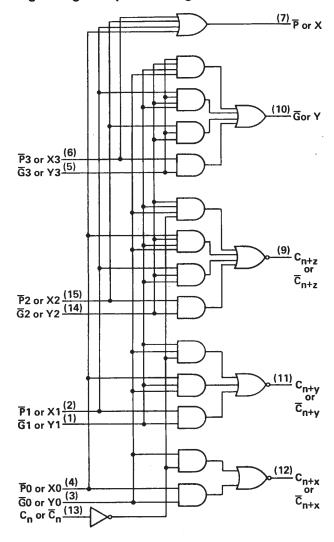
FUNCTION TABLE FOR Cn+z OUTPUT

		II.	NPUT	S			OUTPUT
Ğ2	Ğ1	Ğ0	P2	P1	P0	Cn	C _{n+z}
L	X	Х	Х	Х	Х	X	н
×	L	X	L	L X X L L X	Х	н	
x	X	L	L		X	х х	н
х	X	X	L	L	Н	н	
	All	other	coml	oinati	ons		L

H = high level, L = low level, X = irrelevant

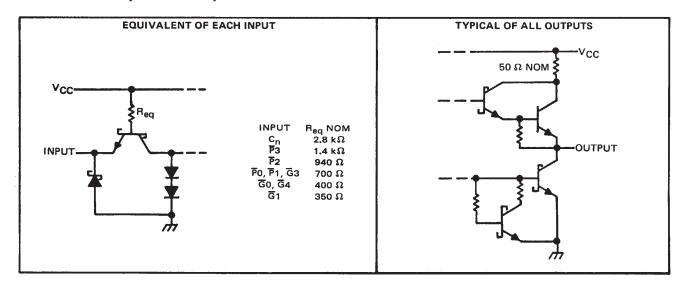
Any inputs not shown in a given table are irrelevant with respect to that output.

logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7	7 V
Input voltage		
Interemitter voltage (see Note 2)	5.5	5 V
Operating free-air temperature range: SN54S182 – 55°C	to 125	°C
SN74S182 0°	'C to 70	°C
Storage temperature range65°C	to 150	°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

2. This is the voltage between two emitters of a multiple-emitter input transistor. For these circuits, this rating applies to each \overline{G} input in conjunction with any other \overline{G} input or in conjunction with any \overline{P} input.

recommended operating conditions

	S	SN54S182			SN74S182		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-1			-1	mA
Low-level output current, IOL			20			20	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAME	TED	TEST CO	NDITIONS†	S	N54S18	32	S	N74S18	32	UNIT
	FARAME	IEN	I EST CO	INDITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage	je			2			2			V
ViL	Low-level input voltag	je					0.8			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	I _I = -18 mA			-1.2			-1.2	V
VOH	High-level output volt	age	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -1 mA	2.5	3.4		2.7	3.4		٧
VOL	Low-level output volta	age	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = 20 mA			0.5			0.5	٧
11	Input current at maxis	mum input voltage	V _{CC} = MAX,	V _I = 5.5 V			1			1	mA
		C _n input					50			50	
		P3 input	V _{CC} = MAX,				100			100	
i	High-level	P2 input		V 27V			150			150	
l liH	input current	PO, P1, or G3 input	CC - WAA,	V - 2.7 V			200			200	μА
		G0 or G2 input					350			350]
		G1 input	1				400			400	1
		C _n input					-2			-2	
		P3 input	1				-4			-4	
	Low-level	P2 input	1,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	V - 0 " V			-6			-6	1
112	input current	PO, P1, or G3 input	V _{CC} = MAX,	V = 0.5 V			-8			-8	mA
	•	GO or G2 input	1				-14			-14	1
1		G1 input	1				-16			-16	1
Ios	Short-circuit output c	urrent§	V _{CC} = MAX		-40		-100	-40		-100	mA
Іссн	30		V _{CC} = 5 V,	See Note 3		35	65		35	70	mA
CCL	Supply current, all ou	tputs low	V _{CC} = MAX,	See Note 4	i	69	99		69	109	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN TYP	MAX	UNIT
tPLH	Go, G1, G2, G3,	C _{n+x} , C _{n+y} ,		4.5	7	ns
tPHL	P0, P1, P2, or P3	or C _{n+z}		4.5	7] '''
tPLH t	G0, G1, G2, G3,	G	7	5	7.5	ns
tPHL.	P1, P2, or P3		$R_L = 280 \Omega$, $C_L = 15 pF$,	7	10.5	113
tPLH	P0, P1, P2, or P3	P	See Note 5	4.5	6.5	ns
tPHL	10,11,12,0113	rs r		6.5	10	7 "
^t PLH	- C _n	C _{n+x} , C _{n+y} , or C _{n+z}		6.5	10	ns
tPH L	on .	or C _{n+z}		7	10.5	113

NOTE 5: Load circuits and voltage waveforms are shown in Section 1.



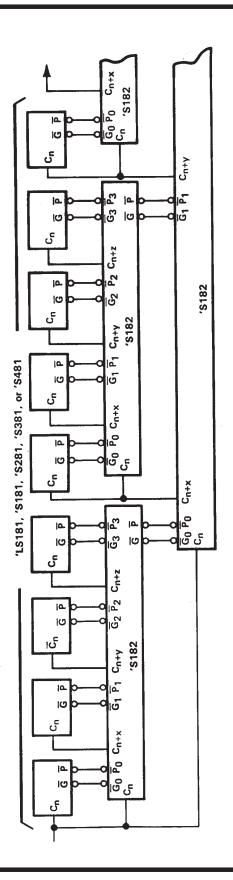
 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time and duration of the short-circuit test should not exceed one second.

NOTES: 3. ICCH is measured with all outputs open, inputs $\overline{P}3$ and $\overline{G}3$ at 4.5 V, and all other inputs grounded. MAX is determined at 5.5 V.

^{4.} ICCL is measured with all outputs open; inputs \$\overline{G0}\$, \$\overline{G1}\$, and \$\overline{G2}\$ at 4.5 V; and all other inputs grounded.

TYPICAL APPLICATION DATA



64-BIT ALU, FULL-CARRY LOOK-AHEAD IN THREE LEVELS

Remaining inputs and outputs of 'LS181, 'S181, 'S281, 'S381, and 'S481 are not shown.

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29-May-2025

PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking
						(4)	(5)		
JM38510/07802BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 07802BEA
JM38510/07802BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 07802BEA
M38510/07802BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 07802BEA
SN54S182J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S182J
SN54S182J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S182J
SNJ54S182FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S 182FK
SNJ54S182FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S 182FK
SNJ54S182J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S182J
SNJ54S182J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S182J

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

www.ti.com 29-May-2025

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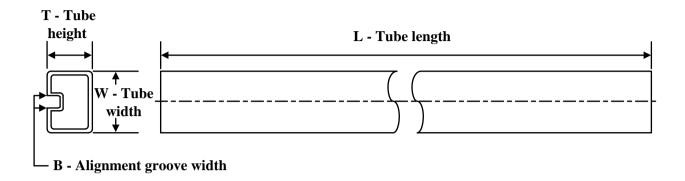
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TUBE



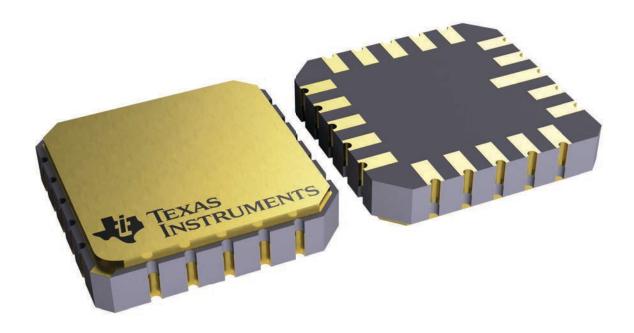
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SNJ54S182FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54S182FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA

8.89 x 8.89, 1.27 mm pitch

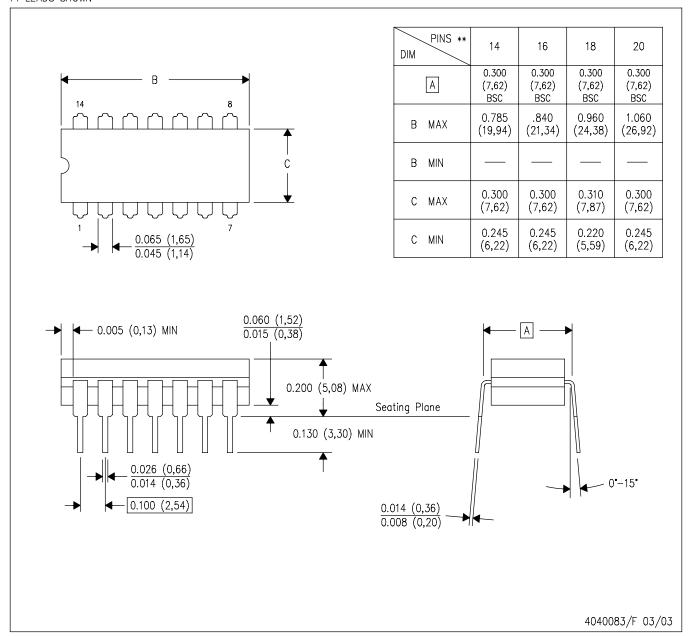
LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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